



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





RF360 Europe GmbH

A Qualcomm – TDK Joint Venture

## SAW Components

### SAW filter

Short range devices

Series/type:	B3737
Ordering code:	B39451B3737H110
Date:	April 23, 2013
Version:	2.1

RF360 products mentioned within this document are offered by RF360 Europe GmbH and other subsidiaries of RF360 Holdings Singapore Pte. Ltd. (collectively, the “RF360 Subsidiaries”). RF360 Holdings Singapore Pte. Ltd. is a joint venture of Qualcomm Global Trading Pte. Ltd. and EPCOS AG. References in this documentation to EPCOS AG should properly reference, and shall be read to reference, the RF360 Subsidiaries.

RF360 Europe GmbH, Anzinger Str. 13, München, Germany

© 2016 RF360 Europe GmbH and/or its affiliated companies. All rights reserved.

These materials, including the information contained herein, may be used only for informational purposes by the customer. The RF360 Subsidiaries assume no responsibility for errors or omissions in these materials or the information contained herein. The RF360 Subsidiaries reserve the right to make changes to the product(s) or information contained herein without notice. The materials and information are provided on an AS IS basis, and the RF360 Subsidiaries assume no liability and make no warranty or representation, either expressed or implied, with respect to the materials, or any output or results based on the use, application, or evaluation of such materials, including, without limitation, with respect to the non-infringement of trademarks, patents, copyrights or any other intellectual property rights or other rights of third parties.

No use of this documentation or any information contained herein grants any license, whether express, implied, by estoppel or otherwise, to any intellectual property rights, including, without limitation, to any patents owned by QUALCOMM Incorporated or any of its subsidiaries.

Not to be used, copied, reproduced, or modified in whole or in part, nor its contents revealed in any manner to others without the express written permission of RF360 Europe GmbH.

Qualcomm and Qualcomm RF360 are trademarks of Qualcomm Incorporated, registered in the United States and other countries. RF360 is a trademark of Qualcomm Incorporated. Other product and brand names may be trademarks or registered trademarks of their respective owners.

This technical data may be subject to U.S. and international export, re-export, or transfer ("export") laws. Diversion contrary to U.S. and international law is strictly prohibited.



# SAW Components

## SAW filter

Short range devices

<b>Series/type:</b>	<b>B3737</b>
<b>Ordering code:</b>	<b>B39451B3737H110</b>
<b>Date:</b>	<b>April 23, 2013</b>
<b>Version:</b>	<b>2.1</b>

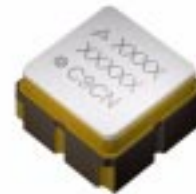
© EPCOS AG 2015. Reproduction, publication and dissemination of this publication, enclosures hereto and the information contained therein without EPCOS' prior express consent is prohibited.

EPCOS AG is a TDK Group Company.

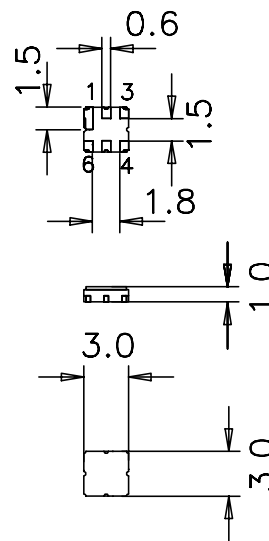
Data sheet


**Application**

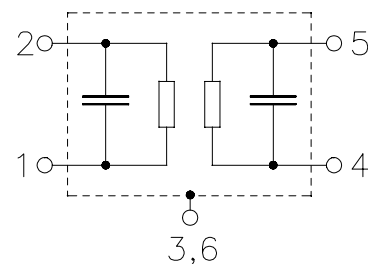
- Low-loss RF filter for remote control receivers and transmitters
- Balanced and unbalanced operation possible


**Features**

- Package size 3.0 x 3.0 x 1.0 mm<sup>3</sup>
- Package code DCC6E
- RoHS compatible
- Approximate weight 0.037 g
- Package for **Surface Mount Technology (SMT)**
- Ni, gold-plated terminals
- Lead free soldering compatible with J - STD20C
- Passivation layer Elpas
- AEC-Q200 qualified component family
- **Electrostatic Sensitive Device (ESD)**


**Pin configuration<sup>1)</sup>**

- 1 Input (recommended) or input ground
- 2 Input ground (recommended) or input
- 4 Output (recommended) or output ground
- 5 Output ground (recommended) or output
- 3,6 To be grounded



1) The recommended pin configuration usually offers best suppression of electrical crosstalk. The filter characteristics refer to this configuration.

**Data sheet**

**Characteristics**

Operating temperature range:	T = -45 °C to +95 °C
Terminating source impedance:	Z <sub>S</sub> = 50 Ω and matching network
Terminating load impedance:	Z <sub>L</sub> = 50 Ω and matching network

		min.	typ. @ 25 °C	max.	
<b>Center frequency</b>	f <sub>C</sub>	—	447.725	—	MHz
<b>Minimum insertion attenuation</b>	α <sub>min</sub>				
incl. loss in matching elements (Q <sub>L</sub> = 47)		—	2.2	3.0	dB
excl. loss in matching elements		—	1.6	2.6	dB
<b>Pass band (relative to α<sub>min</sub>)</b>					
447.60 ... 447.85 MHz		—	0.8	2.0	dB
447.58 ... 447.87 MHz		—	1.0	3.0	dB
447.56 ... 447.91 MHz		—	1.2	6.0	dB
<b>Filter bandwidth</b>					
α <sub>rel</sub> ≤ 3 dB		0.65	0.70	0.75	MHz
<b>Relative attenuation (relative to α<sub>min</sub>)</b>	α <sub>rel</sub>				
10.00 ... 427.80 MHz		50	55	—	dB
427.80 ... 437.30 MHz		45	50	—	dB
437.30 ... 444.72 MHz		30	38	—	dB
444.72 ... 446.72 MHz		15	20	—	dB
448.72 ... 458.22 MHz		12	15	—	dB
458.22 ... 467.72 MHz		40	50	—	dB
467.72 ... 810.00 MHz		42	54	—	dB
810.00 ... 1500.00 MHz		50	65	—	dB
1500.00 ... 2000.00 MHz		45	60	—	dB
<b>Impedance for pass band matching<sup>1)</sup></b>					
Input: Z <sub>IN</sub> = R <sub>IN</sub>    C <sub>IN</sub>		—	340    2.2	—	Ω    pF
Output: Z <sub>OUT</sub> = R <sub>OUT</sub>    C <sub>OUT</sub>		—	340    2.2	—	Ω    pF

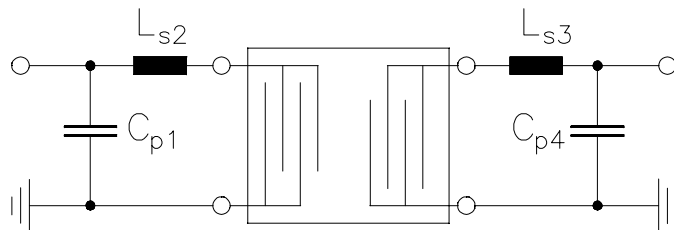
1) Impedance for passband matching bases on an ideal, perfect matching of the SAW filter to source- and to load impedance (here 50 Ohm). After removal of the SAW filter the input impedance of the input and output matching network is calculated. The conjugate complex value of these characteristic impedances are the input and output impedances for flat passband. For more details we refer to EPCOS application note #18.


**Maximum ratings**

Operable temperature range	T	-45/+120	°C	
Storage temperature range	T <sub>stg</sub>	-45/+120	°C	
DC voltage	V <sub>DC</sub>	6	V	
Source power	P <sub>S</sub>	10	dBm	source impedance 50 Ω



**Matching network to 50 Ω** (element values depend on pcb layout and equivalent circuit)



$$C_{p1} = 1.8 \text{ pF}$$

$$L_{s2} = 39 \text{ nH}$$

$$L_{s3} = 39 \text{ nH}$$

$$C_{p4} = 1.8 \text{ pF}$$

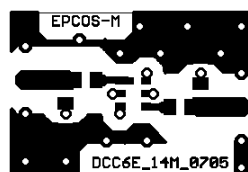
### Minimising the crosstalk

For a good ultimate rejection a low crosstalk is necessary. Low crosstalk can be realised with a good RF layout. The major crosstalk mechanism is caused by the “ground-loop” problem.

Grounding loops are created if input- and output transducer GND are connected on the top-side of the PCB and fed to the system grounding plane by a common via hole. To avoid the common ground path, the ground pin of the input- and output transducer are fed to the system ground plane (bottom PCB plane) by their own via hole. The transducers’ grounding pins should be isolated from the upper grounding plane.

A common GND inductivity of 0.5nH degrades the ultimate rejection (crosstalk) by 20dB.

The optimised PCB layout, including matching network for transformation to 50 Ohm, is shown here. In this PCB layout the grounding loops are minimised to realise good ultimate rejection



Optimised PCB layout for SAW filters in DCC6E package, pinning 1,4 (top side, scale 1:1)

The bottom side is a copper plane (system ground area). The input and output grounding pins are isolated and connected to the common ground by separated via holes.

For good contact of the upper grounding area with the lower side it is necessary to place enough via holes.



Data sheet



### ESD protection of SAW filters

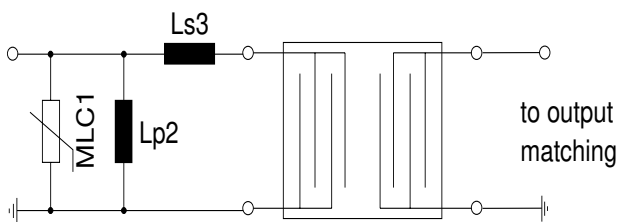
SAW filters are **E**lectro **S**tatic **D**ischarge sensitive devices. To reduce the probability of damages caused by ESD, special matching topologies have to be applied.

In general, “ESD matching” has to be ensured at that filter port, where electrostatic discharge is expected.

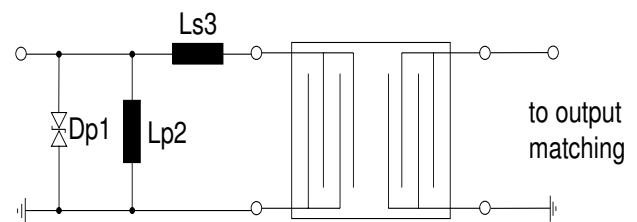
Electrostatic discharges predominantly appear at the antenna input of RF receivers. Therefore only the input matching of the SAW filter has to be designed to short circuit or to block the ESD pulse.

Below two figures show recommended “ESD matching” topologies.

Depending on the input impedance of the SAW filter and the source impedance, the needed component values have to be determined from case to case.

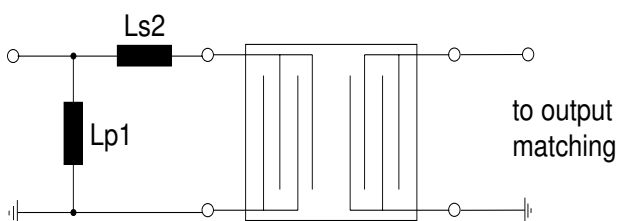


**Fig. 1 MLC varistor plus ESD matching**

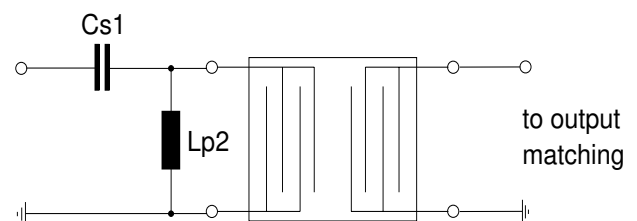


**Fig. 2 Suppressor diode plus ESD matching**

In cases where minor ESD occur, following simplified “ESD matching” topologies can be used alternatively.



**Fig. 3 shunt L – series L matching**



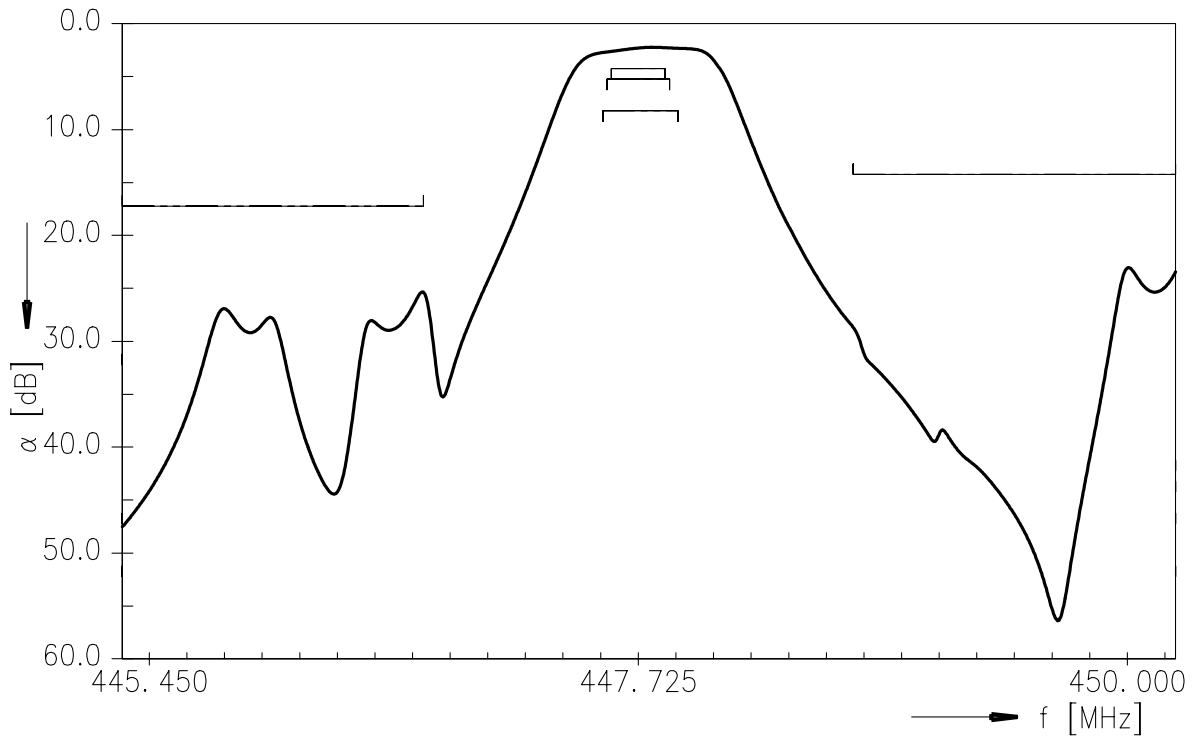
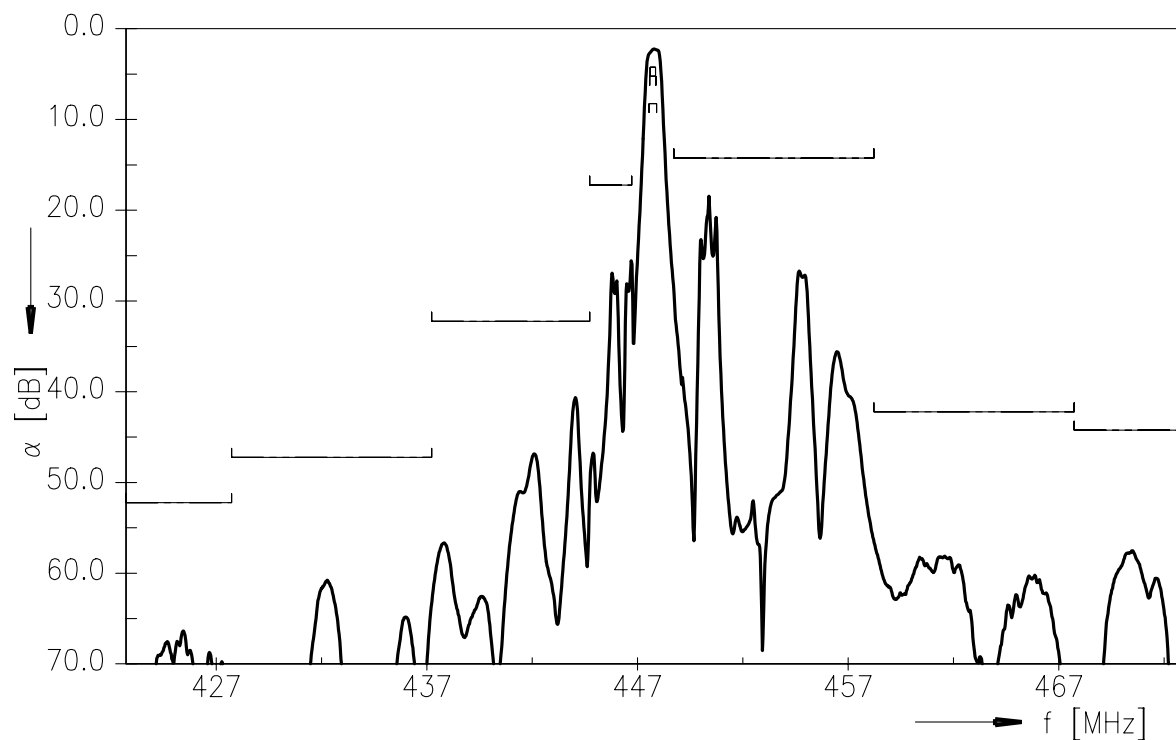
**Fig. 4 series C – shunt L matching**

Effectiveness of the applied ESD protection has to be checked according to relevant industry standards or customer specific requirements.

For further information, please refer to EPCOS Application report:

“**ESD protection for SAW filters**”. This report can be found under [www.epcos.com/rke](http://www.epcos.com/rke). Click on “data sheets” and then “Applications” under category “Further information”.

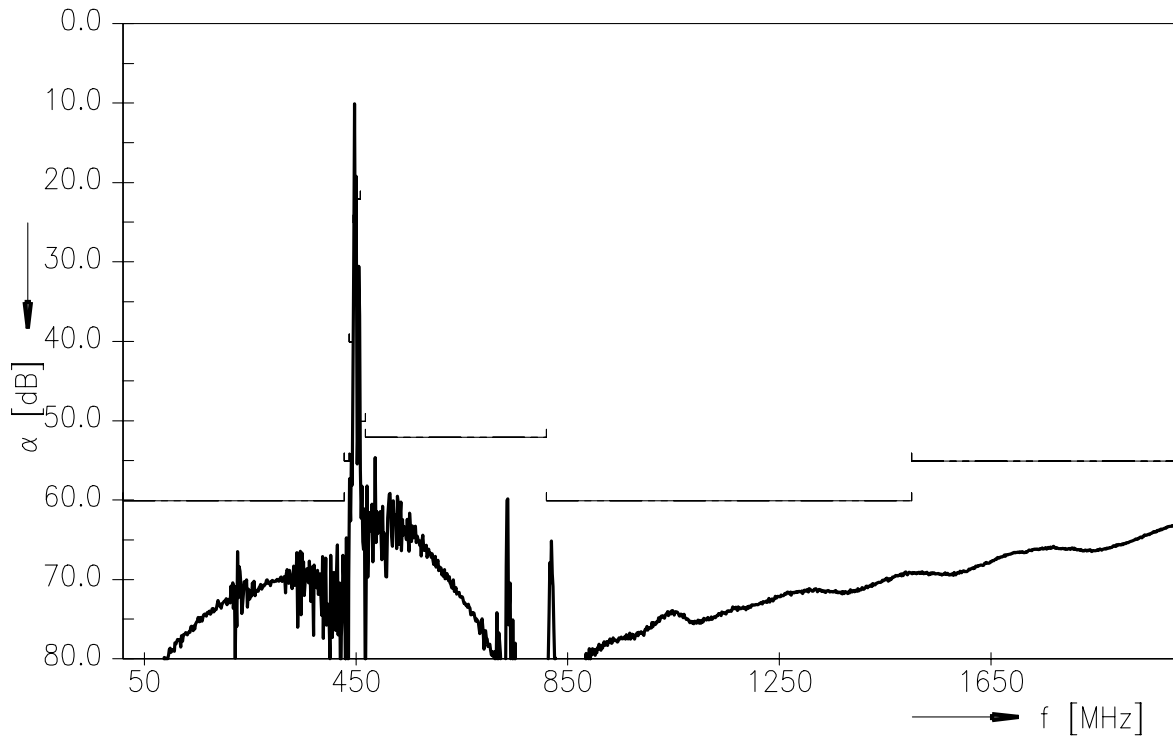
Data sheet


**Transfer function**

**Transfer function (wideband)**


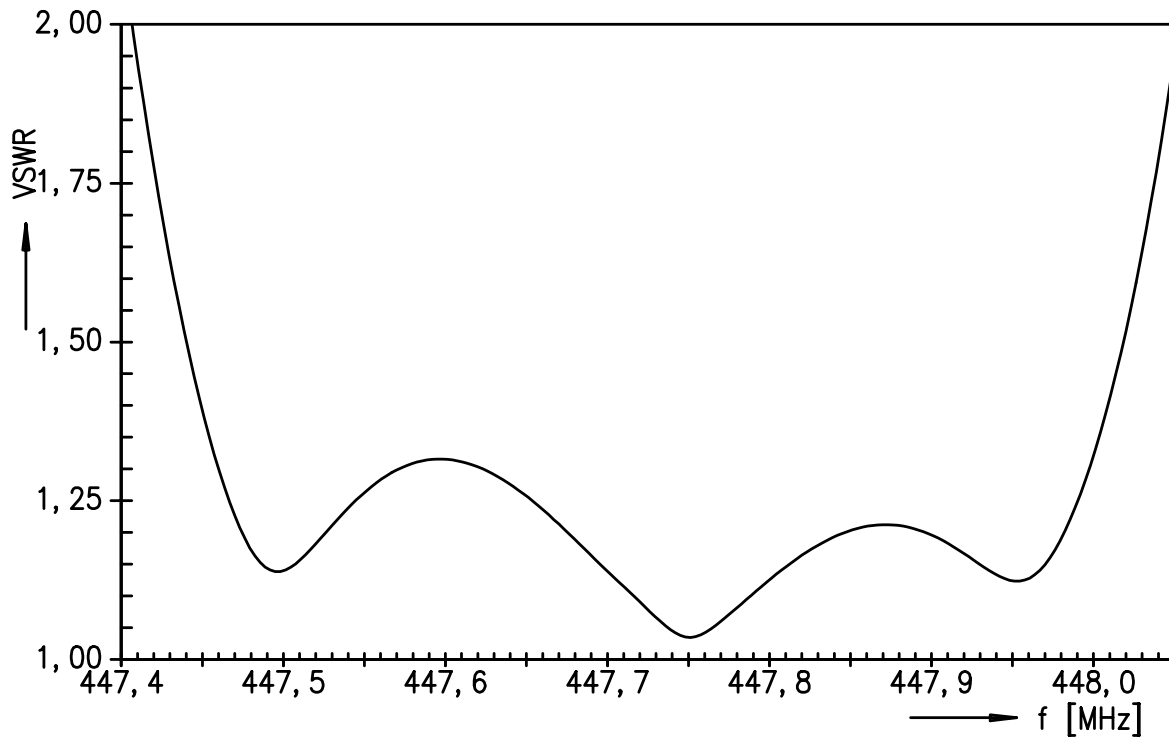
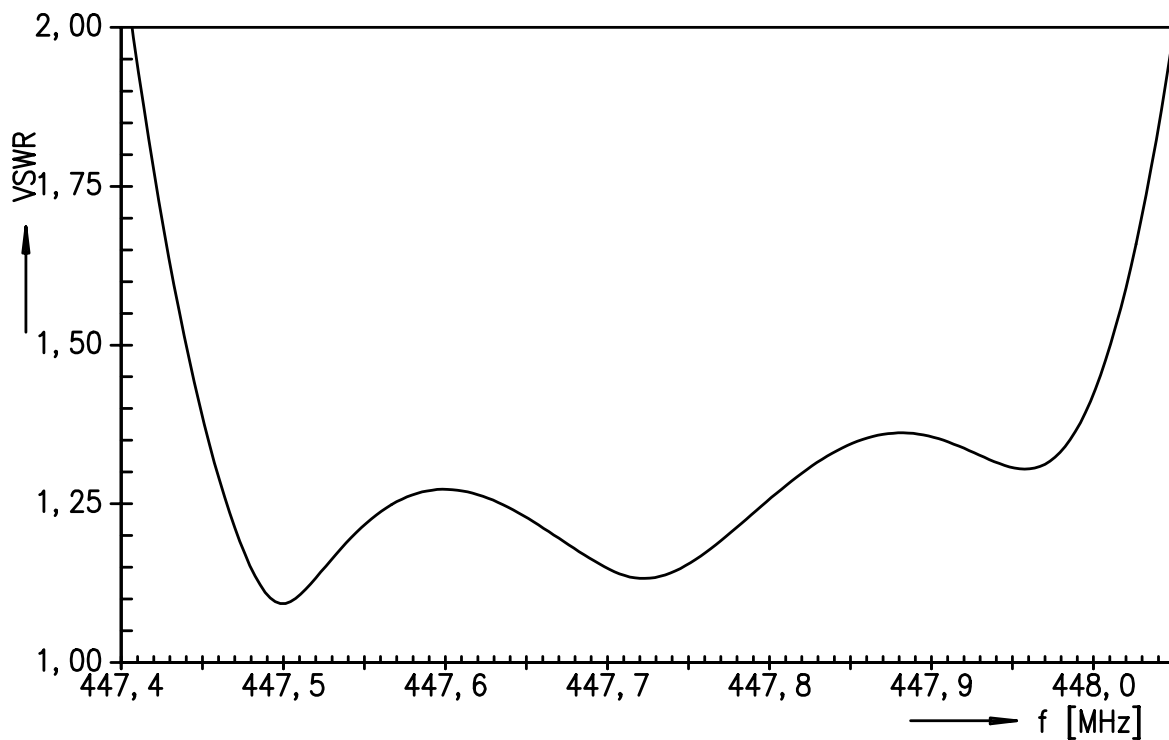
Data sheet



**Transfer function (ultimate rejection)**



Data sheet


**Input VSWR**

**Output VSWR**



**References**

<b>Type</b>	B3737
<b>Ordering code</b>	B39451B3737H110
<b>Marking and package</b>	C61157-A7-A143
<b>Packaging</b>	F61074-V8168-Z000
<b>Date codes</b>	L_1126
<b>S-parameters</b>	B3737_NB.s2p, B3737_WB.s2p See file header for port/pin assignment table.
<b>Soldering profile</b>	S_6001
<b>RoHS compatible</b>	RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8 <sup>th</sup> , 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.
<b>Matching coils</b>	See Inductor pdf-catalog <a href="http://www.tdk.co.jp/tefe02/coil.htm#aname1">http://www.tdk.co.jp/tefe02/coil.htm#aname1</a> and Data Library for circuit simulation <a href="http://www.tdk.co.jp/etvcl/index.htm">http://www.tdk.co.jp/etvcl/index.htm</a>

For further information please contact your local EPCOS sales office or visit our webpage at [www.epcos.com](http://www.epcos.com).

**Published by EPCOS AG**  
**Systems, Acoustics, Waves Business Group**  
**P.O. Box 80 17 09, 81617 Munich, GERMANY**

© EPCOS AG 2013. This brochure replaces the previous edition.

For questions on technology, prices and delivery please contact the Sales Offices of EPCOS AG or the international Representatives.

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our Sales Offices.

## Important notes

The following applies to all products named in this publication:

1. Some parts of this publication contain **statements about the suitability of our products for certain areas of application**. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out **that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application**. As a rule, EPCOS is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an EPCOS product with the properties described in the product specification is suitable for use in a particular customer application.
2. We also point out that **in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified**. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
3. **The warnings, cautions and product-specific notes must be observed.**
4. In order to satisfy certain technical requirements, **some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous)**. Useful information on this will be found in our Material Data Sheets on the Internet ([www.epcos.com/material](http://www.epcos.com/material)). Should you have any more detailed questions, please contact our sales offices.
5. We constantly strive to improve our products. Consequently, **the products described in this publication may change from time to time**. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also **reserve the right to discontinue production and delivery of products**. Consequently, we cannot guarantee that all products named in this publication will always be available. The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.
6. Unless otherwise agreed in individual contracts, **all orders are subject to the current version of the “General Terms of Delivery for Products and Services in the Electrical Industry” published by the German Electrical and Electronics Industry Association (ZVEI)**.
7. The trade names EPCOS, BAOKE, Alu-X, CeraDiode, CeraLink, CSMP, CSSP, CTVS, DeltaCap, DigiSiMic, DSSP, FilterCap, FormFit, MiniBlue, MiniCell, MKD, MKK, MLSC, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, SIP5D, SIP5K, ThermoFuse, WindCap are **trademarks registered or pending** in Europe and in other countries. Further information will be found on the Internet at [www.epcos.com/trademarks](http://www.epcos.com/trademarks).